
Dielectric Materials And Applications

Principles and Applications

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Dielectric Materials for Wireless Communication

Proceedings of Workshop for Dielectric Materials
and Applications, January 5-6, 2000

Ferroelectrics

Handbook of Advanced Dielectric, Piezoelectric
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Microwave Materials and Applications, 2 Volume
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Proceedings of the 12th Pacific Rim Conference
on Ceramic and Glass Technology; Ceramic

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Dielectric Materials and Applications

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Fundamentals and Applications

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Dielectric Materials

Introduction, Research and Applications

Electrical, Dielectric, Electromagnetic, Optical and
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Papers

Ferroelectric Materials for Energy Applications

Handbook of Low and High Dielectric Constant

Materials and Their Applications, Two-Volume Set

ISyDMA'2016

Dielectric materials and applications

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Materials
And
Applications*

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FRENCH LAILA

Principles and

Applications John Wiley
& Sons

Explore the diverse
electrical engineering
application of polymer

composite materials with this in-depth collection edited by leaders in the field Polymer Composites for Electrical Engineering delivers a comprehensive exploration of the fundamental principles, state-of-the-art research, and future challenges of polymer composites. Written from the perspective of electrical engineering applications, like electrical and thermal energy storage, high temperature applications, fire retardance, power cables, electric stress control, and others, the book covers all major application branches of these widely used materials. Rather than focus on polymer composite materials themselves, the distinguished editors

have chosen to collect contributions from industry leaders in the area of real and practical electrical engineering applications of polymer composites. The books relevance will only increase as advanced polymer composites receive more attention and interest in the area of advanced electronic devices and electric power equipment. Unique amongst its peers, Polymer Composites for Electrical Engineering offers readers a collection of practical and insightful materials that will be of great interest to both academic and industrial audiences. Those resources include: A comprehensive discussion of glass fiber reinforced

polymer composites for power equipment, including GIS, bushing, transformers, and more) Explorations of polymer composites for capacitors, outdoor insulation, electric stress control, power cable insulation, electrical and thermal energy storage, and high temperature applications A treatment of semi-conductive polymer composites for power cables In-depth analysis of fire-retardant polymer composites for electrical engineering An examination of polymer composite conductors Perfect for postgraduate students and researchers working in the fields of electrical, electronic, and polymer engineering, Polymer Composites for

Electrical Engineering will also earn a place in the libraries of those working in the areas of composite materials, energy science and technology, and nanotechnology.

Dielectric Materials and Applications CRC Press

Microwave dielectric materials play a key role in our global society with a wide range of applications, from terrestrial and satellite communication including software radio, GPS, and DBS TV to environmental monitoring via satellite. A small ceramic component made from a dielectric material is fundamental to the operation of filters and oscillators in several microwave systems. In microwave communications,

dielectric resonator filters are used to discriminate between wanted and unwanted signal frequencies in the transmitted and received signal. When the wanted frequency is extracted and detected, it is necessary to maintain a strong signal. For clarity it is also critical that the wanted signal frequencies are not affected by seasonal temperature changes. In order to meet the specifications of current and future systems, improved or new microwave components based on dedicated dielectric materials and new designs are required. The recent progress in microwave telecommunication, satellite broadcasting and intelligent transport systems (ITS)

has resulted in an increased demand for Dielectric Resonators (DRs). With the recent revolution in mobile phone and satellite communication systems using microwaves as the propagation media, the research and development in the field of device miniaturization has been a major challenge in contemporary Materials Science. In a mobile phone communication, the message is sent from a phone to the nearest base station, and then on via a series of base stations to the other phone. At the heart of each base station is the combiner/filter unit which has the job of receiving the messages, keeping them separate, amplifying the signals

and sending then onto the next base station. For such a microwave circuit to work, part of it needs to resonate at the specific working frequency. The frequency determining component (resonator) used in such a high frequency device must satisfy certain criteria. The three important characteristics required for a dielectric resonator are (a) a high dielectric constant which facilitates miniaturization (b) a high quality factor (Q_{xf}) which improves the signal-to-noise ratio, (c) a low temperature coefficient of the resonant frequency which determines the stability of the transmitted frequency. During the past 25 years scientists the world over have

developed a large number of new materials (about 3000) or improved the properties of known materials. About 5000 papers have been published and more than 1000 patents filed in the area of dielectric resonators and related technologies. This book brings the data and science of these several useful materials together, which will be of immense benefit to researchers and engineers the world over. The topics covered in the book includes factors affecting the dielectric properties, measurement of dielectric properties, important low loss dielectric material systems such as perovskites, tungsten bronze type materials,

materials in BaO-TiO₂ system, (Zr,Sn)TiO₄, alumina, rutile, AnBn-10₃n type materials, LTCC, ceramic-polymer composites etc. The book also has a data table listing all reported low loss dielectric materials with properties and references arranged in the order of increasing dielectric constant. Collects together in one source data on all new materials used in wireless communication Includes tabulated properties of all reported low loss dielectric materials In-depth treatment of dielectric resonator materials
Dielectric Materials for Wireless Communication
Elsevier
Dielectric

Metamaterials: Fundamentals, Designs and Applications links fundamental Mie scattering theory with the latest dielectric metamaterial research, providing a valuable reference for new and experienced researchers in the field. The book begins with a historical, evolving overview of Mie scattering theory. Next, the authors describe how to apply Mie theory to analytically solve the scattering of electromagnetic waves by subwavelength particles. Later chapters focus on Mie resonator-based metamaterials, starting with microwaves where particles are much smaller than the free space wavelengths. In addition, several chapters focus on

wave-front engineering using dielectric metasurfaces and the nonlinear optical effects, spontaneous emission manipulation, active devices, and 3D effective media using dielectric metamaterials.

Highlights a crucial link in fundamental Mie scattering theory with the latest dielectric metamaterial research spanning materials, design and applications Includes coverage of wave-front engineering and 3D metamaterials Provides computational codes for calculating and simulating Mie resonances

**Proceedings of
Workshop for
Dielectric Materials
and Applications,
January 5-6, 2000**

John Wiley & Sons

The topic of thin films is an area of increasing

importance in materials science, electrical engineering and applied solid state physics; with both research and industrial applications in microelectronics, computer manufacturing, and physical devices. Advanced, high-performance computers, high-definition TV, broadband imaging systems, flat-panel displays, robotic systems, and medical electronics and diagnostics are a few examples of the miniaturized device technologies that depend on the utilization of thin film materials. This book presents an in-depth overview of the novel developments made by the scientific leaders in the area of modern

dielectric films for advanced microelectronic applications. It contains clear, concise explanations of material science of dielectric films and their problem for device operation, including high-k, low-k, medium-k dielectric films and also specific features and requirements for dielectric films used in the packaging technology. A broad range of related topics are covered, from physical principles to design, fabrication, characterization, and applications of novel dielectric films.

Ferroelectrics

Academic Press

"The book Dielectric Materials and Applications focuses on the recent research advancements in the

area of dielectrics that can be utilized in a variety of technology-oriented applications. The topics covered in this book include the investigations of materials having low dielectric constants for Cu interconnects, a two-layer metallic waveguide as a tool to determine the complex permittivity of liquids and/or clinical diagnostics, microwave dielectric materials for the miniaturization of portable electronic devices, microwave assisted heating of dielectric and composite materials, and the dielectric properties of certain 3D nanocomposites. The other areas of discussion encapsulate the modeling of supershaped dielectric lens antennas, the roles of dielectric

mediums in metamaterials to realize photonic devices ranging from absorbers, sensors and communication systems. Some of the chapters are purely experimental, whereas some others are based on modeling and simulation. Reading this volume truly remains key to understanding novel applications of dielectric materials in different areas of technological interest"-

- Handbook of Advanced Dielectric, Piezoelectric and Ferroelectric Materials Elsevier

Examines the advantages of Embedded and FO-WLP technologies, potential application spaces, package structures available in the industry, process flows,

and material challenges Embedded and fan-out wafer level packaging (FO-WLP) technologies have been developed across the industry over the past 15 years and have been in high volume manufacturing for nearly a decade. This book covers the advances that have been made in this new packaging technology and discusses the many benefits it provides to the electronic packaging industry and supply chain. It provides a compact overview of the major types of technologies offered in this field, on what is available, how it is processed, what is driving its development, and the pros and cons. Filled with contributions from some of the field's

leading experts, Advances in Embedded and Fan-Out Wafer Level Packaging Technologies begins with a look at the history of the technology. It then goes on to examine the biggest technology and marketing trends. Other sections are dedicated to chip-first FO-WLP, chip-last FO-WLP, embedded die packaging, materials challenges, equipment challenges, and resulting technology fusions. Discusses specific company standards and their development results Content relates to practice as well as to contemporary and future challenges in electronics system integration and packaging Advances in Embedded and Fan-Out Wafer Level

Packaging Technologies will appeal to microelectronic packaging engineers, managers, and decision makers working in OEMs, IDMs, IFMs, OSATs, silicon foundries, materials suppliers, equipment suppliers, and CAD tool suppliers. It is also an excellent book for professors and graduate students working in microelectronic packaging research. *Polymer Composites for Electrical Engineering* World Scientific Publishing Company The development of functional materials is at the heart of technological needs and the forefront of materials research. This book provides a comprehensive and up-

to-date treatment of functional materials, which are needed for electrical, dielectric, electromagnetic, optical, and magnetic applications. Materials concepts covered are strongly linked to applications. Textbooks related to functional materials have not kept pace with technological needs and associated scientific advances. Introductory materials science textbooks merely gloss over functional materials while electronic materials textbooks focus on semiconductors and smart materials textbooks emphasize more on limited properties that pertain to structures. Functional Materials assumes that the readers have had a

one-semester introductory undergraduate course on materials science. The coverage on functional materials is much broader and deeper than that of an introductory materials science course. The book features hundreds of illustrations to help explain concepts and provide quantitative information. The style is general towards tutorial. Most chapters include sections on example problems, review questions and supplementary reading. This book is suitable for use as a textbook in undergraduate and graduate engineering courses. It is also suitable for use as a reference book for professionals in the electronic, computer,

communication, aerospace, automotive, transportation, construction, energy and control industries.

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Dielectric Materials and Applications Elsevier

Low dielectric materials are an important component of microelectronic devices. In this carefully edited volume the leading researchers give an introduction to and a survey of the various fields of dielectrics for IC integration. The book appeals to materials reserachers, electrical engineers and advanced students.

Papers by 22 Contrib

Nova Science Pub

Incorporated

The First International Symposium on Dielectric Materials and Applications

(ISyDMA'2016) was held in Kenitra (4 May, 2016) and in Rabat (May 5-6, 2016), Morocco. ISyDMA'2016 provided an international forum for reporting the most recent developments in Advanced Dielectric Materials and applications. The goal of this collection of peer reviewed papers is to provide researchers and scientists from all over the world with recent developments in dielectric materials and their innovative applications. The book will be useful for materials scientists, physicists, chemists, biologists, and electrical engineers engaged in fundamental and applied research or technical investigations of such materials.

Dielectric Materials and Applications Nova

Science Pub

Incorporated

This comprehensive book covers recent developments in advanced dielectric, piezoelectric and ferroelectric materials. Dielectric materials such as ceramics are used to manufacture microelectronic devices. Piezoelectric components have been used for many years in radioelectronics, time-keeping and, more recently, in microprocessor-based devices. Ferroelectric materials are widely used in various devices such as piezoelectric/electrostrictive transducers and actuators, pyroelectric infrared detectors, optical integrated circuits, optical data storage and display

devices. The book is divided into eight parts under the general headings: High strain high performance piezo- and ferroelectric single crystals; Electric field-induced effects and domain engineering; Morphotropic phase boundary related phenomena; High power piezoelectric and microwave dielectric materials; Nanoscale piezo- and ferroelectrics; Piezo- and ferroelectric films; Novel processing and new materials; Novel properties of ferroelectrics and related materials. Each chapter looks at key recent research on these materials, their properties and potential applications. Advanced dielectric, piezoelectric and ferroelectric materials

is an important reference tool for all those working in the area of electrical and electronic materials in general and dielectrics, piezoelectrics and ferroelectrics in particular. Covers the latest developments in advanced dielectric, piezoelectric and ferroelectric materials Includes topics such as high strain high performance piezo and ferroelectric single crystals Discusses novel processing and new materials, and novel properties of ferroelectrics and related materials

Dielectric Materials and Applications

Woodhead Publishing
A state-of-the-art overview of high-k dielectric materials for advanced field-effect transistors, from both a fundamental and a

technological viewpoint, summarizing the latest research results and development solutions. As such, the book clearly discusses the advantages of these materials over conventional materials and also addresses the issues that accompany their integration into existing production technologies. Aimed at academia and industry alike, this monograph combines introductory parts for newcomers to the field as well as advanced sections with directly applicable solutions for experienced researchers and developers in materials science, physics and electrical engineering. Papers by 22 Contributors Acs Professional Reference Boo

Ceramic Transactions, Volume 264, Proceedings of the 12th Pacific Rim Conference on Ceramic and Glass Technology Dileep Singh, Manabu Fukushima, Young-Wook Kim, Kiyoshi Shimamura, Nobuhito Imanaka, Tatsuki Ohji, Jake Amoroso, and Michael Lanagan; Editors This proceedings contains a collection of 32 papers presented at the 12th Pacific Rim Conference on Ceramic and Glass Technology (PacRim12), May 21-26, 2017 in Waikoloa, Hawaii. PacRim is a bi-annual conference held in collaboration with the ceramic societies of the Pacific Rim countries - The American Ceramic Society, The Chinese Ceramic Society, The

Korean Ceramic Society, and the Australian Ceramic Society. Topics included in this collection include multiscale modeling and simulation, processing and manufacturing, nanotechnology, multifunctional materials, ceramics for energy and the environment, biomedical materials, and more *High Dielectric Constant Materials* Springer Science & Business Media Recent developments in microelectronics technologies have created a great demand for interlayer dielectric materials with a very low dielectric constant. They will play a crucial role in the future generation of IC

devices (VLSI/UISI and high speed IC packaging). Considerable efforts have been made to develop new low as well as high dielectric constant materials for applications in electronics industries. Besides achieving either low or high dielectric constants, other materials' properties such as good processability, high mechanical strength, high thermal and environmental stability, low thermal expansion, low current leakage, low moisture absorption, corrosion resistant, etc., are of equal importance. Many chemical and physical strategies have been employed to get desired dielectric materials with high performance. This is a rapidly growing field of

science--both in novel materials and their applications to future packing technologies. The experimental data on inorganic and organic materials having low or high dielectric constant remain scattered in the literature. It is timely, therefore, to consolidate the current knowledge on low and high dielectric constant materials into a single reference source. Handbook of Low and High Dielectric Constant Materials and Their Applications is aimed at bringing together under a single cover (in two volumes) all low and high dielectric constant materials currently studied in academic and industrial research covering all aspects of inorganic and organic materials from their

synthetic chemistry, processing techniques, physics, structure-property relationship to applications in IC devices. This book will summarize the current status of the field covering important scientific developments made over the past decade with contributions from internationally recognized experts from all over the world. Fully cross-referenced, this book has clear, precise, and wide appeal as an essential reference source for all those interested in low and high dielectric constant material.

VLSI MOSFET

Applications John Wiley & Sons

This volume explores and addresses the challenges of high-k gate dielectric materials, one of the

major concerns in the evolving semiconductor industry and the International Technology Roadmap for Semiconductors (ITRS). The application of high-k gate dielectric materials is a promising strategy that allows further miniaturization of microelectronic components. This book presents a broad review of SiO₂ materials, including a brief historical note of Moore's law, followed by reliability issues of the SiO₂ based MOS transistor. It goes on to discuss the transition of gate dielectrics with an EOT ~ 1 nm and a selection of high-k materials. A review of the various deposition techniques of different high-k films is also discussed. High-k dielectrics theories

(quantum tunneling effects and interface engineering theory) and applications of different novel MOSFET structures, like tunneling FET, are also covered in this book. The volume also looks at the important issues in the future of CMOS technology and presents an analysis of interface charge densities with the high-k material tantalum pentoxide. The issue of CMOS VLSI technology with the high-k gate dielectric materials is covered as is the advanced MOSFET structure, with its working structure and modeling. This timely volume will prove to be a valuable resource on both the fundamentals and the successful integration of high-k dielectric materials in future IC technology.

Dielectric Materials and Applications Artech House Publishers
Beginning with a complete discussion of the fundamentals of dielectric spectroscopy, this book examines in detail the methods used in data modeling and in such specialized techniques as high-frequency dielectric measurements and thermally stimulated currents. The book covers applications in a range of polymeric systems including solutions, blends, and liquid crystals.

**Fundamentals,
Materials, Devices,
Models and
Applications of an
Emerging
Electroactive
Polymer Technology**

Nova Science
Publishers
The First International
Symposium on

Dielectric Materials and Applications (ISyDMA'2016) was held in Kenitra (4 May, 2016) and in Rabat (May 5-6, 2016), Morocco. ISyDMA'2016 provided an international forum for reporting the most recent developments in Advanced Dielectric Materials and applications. The goal of this collection of peer reviewed papers is to provide researchers and scientists from all over the world with recent developments in dielectric materials and their innovative applications. The book will be useful for materials scientists, physicists, chemists, biologists, and electrical engineers engaged in fundamental and applied research or

technical investigations of such materials.

Papers by Twentieth Contributors

John Wiley & Sons
Dielectric Materials and Applications
Artech House
Publishers
Dielectric Materials and Applications
Dielectric Materials and Applications
Nova Science Publishers
Dielectric Materials and Applications. Papers by Twenty-two Contributors. R. Von Hippel, Editor
Mit Press
Combining both fundamental principles and real-life applications in a single volume, this book discusses the latest research results in ferroelectrics, including many new ferroelectric materials for the latest technologies, such as capacitors, transducers and memories. The

first two chapters introduce dielectrics and microscopic materials properties, while the following chapter discusses pyroelectricity and piezoelectricity. The larger part of the text is devoted to ferroelectricity and ferroelectric ceramics, with not only their fundamentals but also applications discussed. The book concludes with a look at the future for laser printed materials and applications. With over 600 references to recent publications on piezoelectric and ferroelectric materials, this is an invaluable reference for physicists, materials scientists and engineers.

Microwave Materials and Applications, 2 Volume Set John

Wiley & Sons

An introduction to the physics of electrical insulation, this book presents the physical foundations of this discipline and the resulting applications. It is structured in two parts. The first part presents a mathematical and intuitive approach to dielectrics; various concepts, including polarization, induction, forces and losses are discussed. The second part provides readers with the keys to understanding the physics of solid, liquid and gas insulation. It comprises a phenomenological description of discharges in gas and its resulting applications. Finally, the main electrical properties of liquids and solids are

presented, in order to explain the phenomena of electrical degradation, dissipation and breakdown. Contents

1. Mathematical Examination of Dielectrics

2. Physical Examination of Dielectrics

Appendix 1. List of Figures

Appendix 2. List of Symbols

Appendix 3. List of Useful Values

Appendix 4. Reminder about Dielectric Spectroscopy

Appendix 5. Reminder about Transitory Currents

Synthesis, Properties and Applications John Wiley & Sons

This book focuses on the fundamentals, technologies and properties of ion irradiation of dielectric materials (e.g. glasses, crystals) with regard to various photonic applications. It

introduces readers to diverse ion-beam techniques for the fabrication and modification of micron- or nanoscale photonic structures, including optical waveguides, photonic crystals, and nanoparticle (nanospheres and nanorods) systems, and presents state-of-the-art advances in this multi-disciplinary research field, demonstrating the unique capabilities of ion-beam technologies in optical dielectric materials processing. The book discusses in detail the properties of ion-beam processed waveguides, as well as the modification of dielectrics for photonic applications, such as electro-optic modulation, nonlinear frequency conversion, waveguide

amplification and lasing. It also explores synthesis and the correlated optical effects of nanoparticles by ion beams, and features examples of successful micro- and

nano-phonic devices. Given its breadth of coverage, the book will particularly appeal to readers interested in ion-beam technology, materials science, and integrated optics.

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